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Review of Anti-Reflection Sol-Gel Coatings in High Energy Lasers

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May 10, 2016

Review of Anti-Reflection Sol-Gel Coatings in High Energy Lasers

Madison, WI, United States

May 22, 2016 through May 26, 2016

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Review of Anti-Reflection Sol-Gel Coatings in High Energy Lasers

GOMD 2016 Madison, WI

Symposium 5: Festschrift for Professor Donald R. Uhlmann

Session title: Legacy

Room: Madison

May 24, 2016 4:00PM

Tayyab Suratwala
Optics and Materials Science & Technology

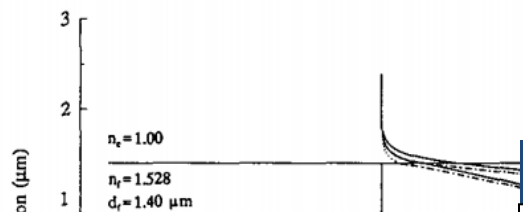


1963



Sol Gel derived materials is amongst the many scientific areas Prof. Uhlmann has contributed in his career

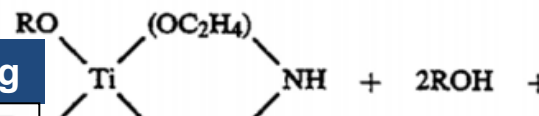
Optical Planar Waveguides



Ferroelectric PZT films

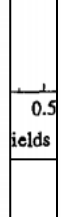


G. Teowee et. al.



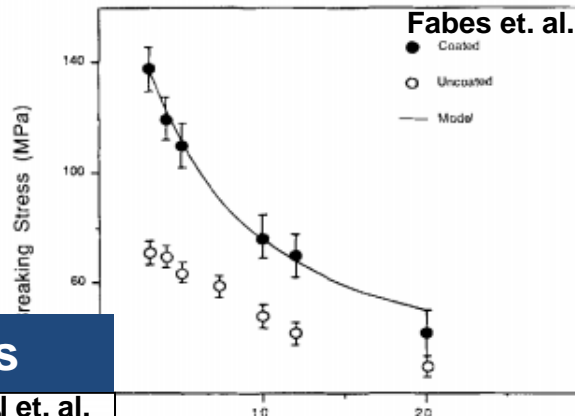
Crystallization

Zelinski et. al.



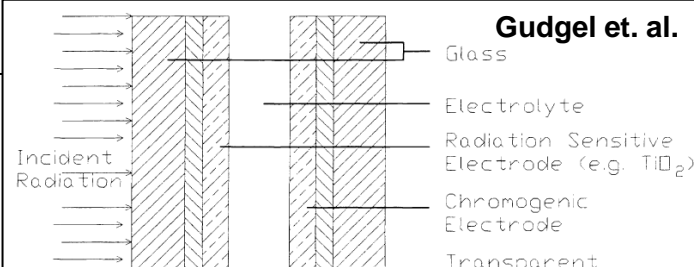
Coatings for glass strengthening

Fabes et. al.



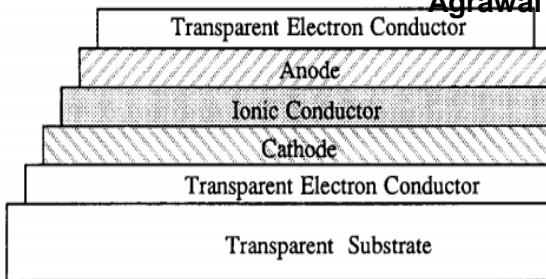
Photochromic Films

Gudgel et. al.

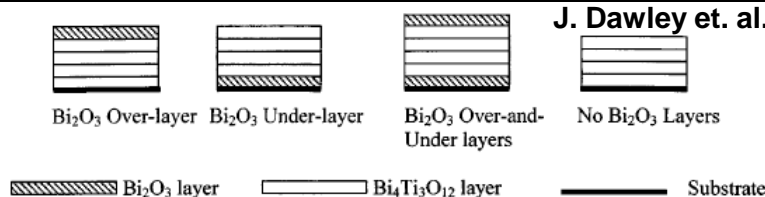


Electrochromic Films

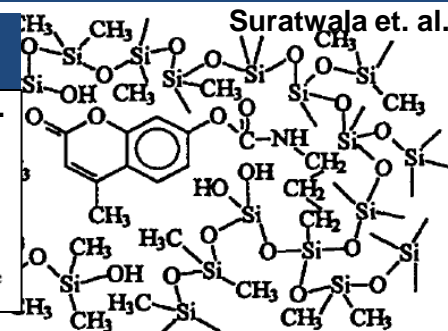
Agrawal et. al.



Bismuth titanate films



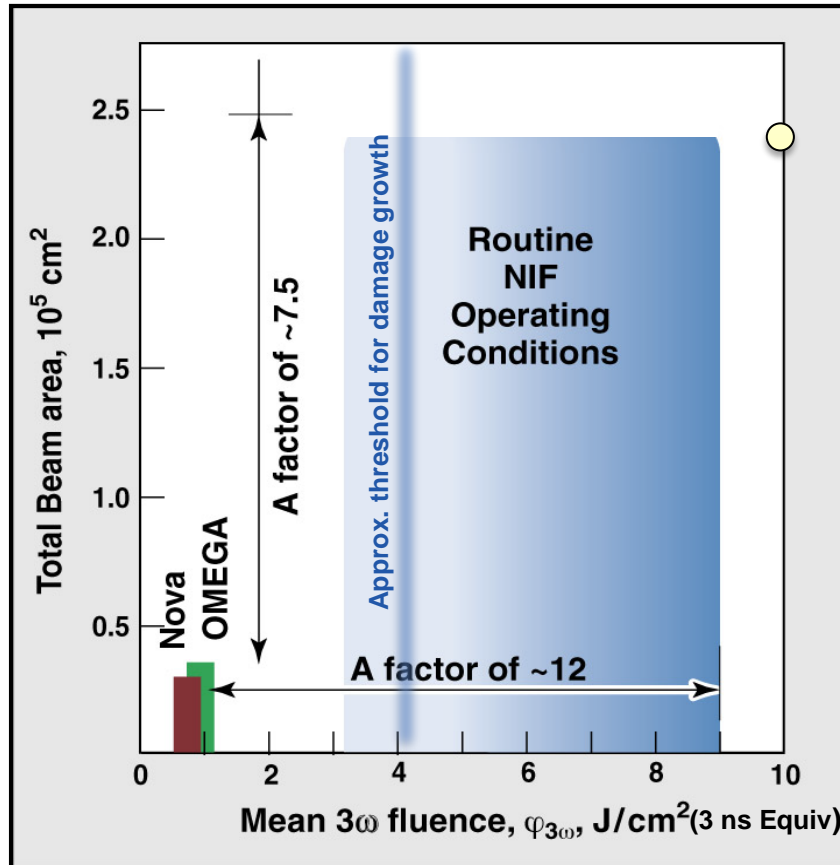
Solid State Dye Lasers



National Ignition Facility (NIF)

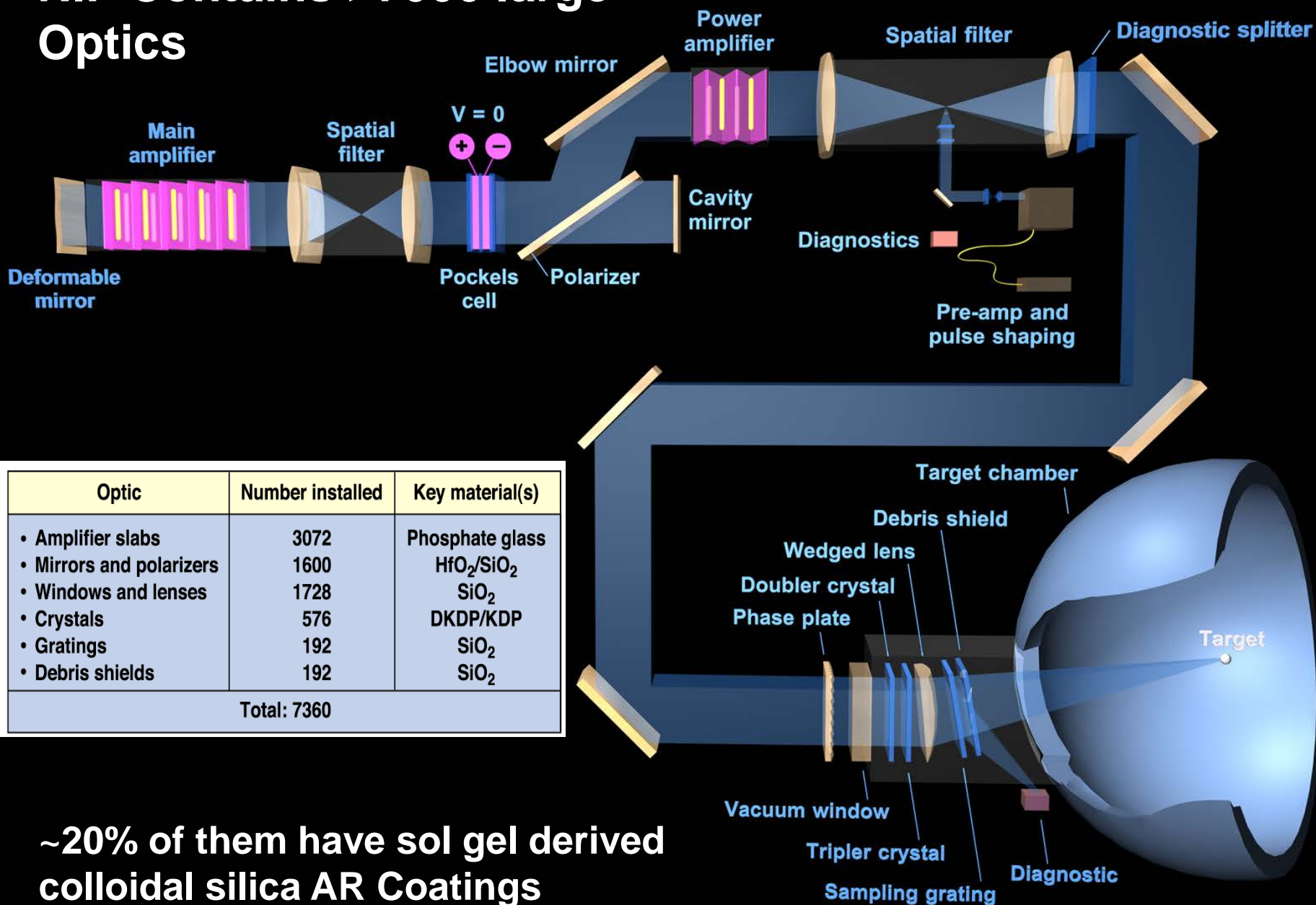


NIF is unique compared to all other lasers built to study Inertial Confinement Fusion



- The NIF 3ω energy specification of 1.8 MJ requires an order of magnitude increase in operating fluence over previous ICF lasers
- The optics loop recycle strategy allows NIF to operate above the 3ω damage limit

NIF Contains >7000 large Optics

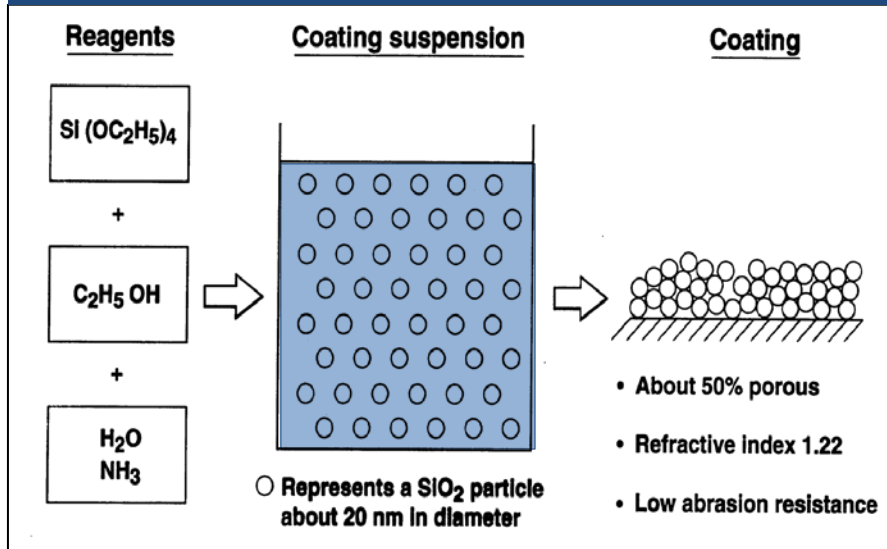


Optic	Number installed	Key material(s)
• Amplifier slabs	3072	Phosphate glass
• Mirrors and polarizers	1600	HfO ₂ /SiO ₂
• Windows and lenses	1728	SiO ₂
• Crystals	576	DKDP/KDP
• Gratings	192	SiO ₂
• Debris shields	192	SiO ₂
Total: 7360		

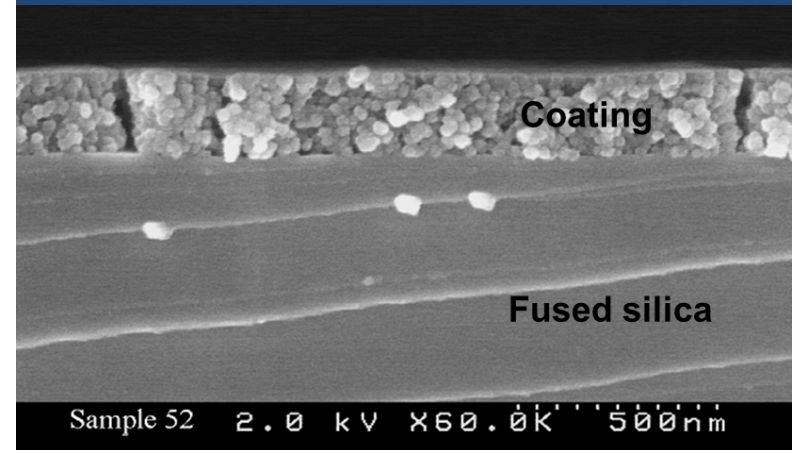
~20% of them have sol gel derived colloidal silica AR Coatings

Damage resistant antireflection (AR) coating are made from sol-gel derived colloidal silica

Stöber silica colloids are made by the sol-gel process



SEM cross section image of colloidal silica AR coating

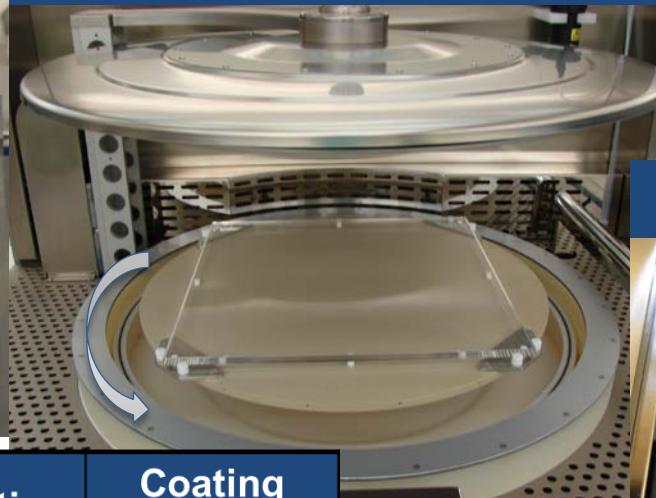


Three methods are used deposit the AR Coating on large optics using various sol compositions on various optics

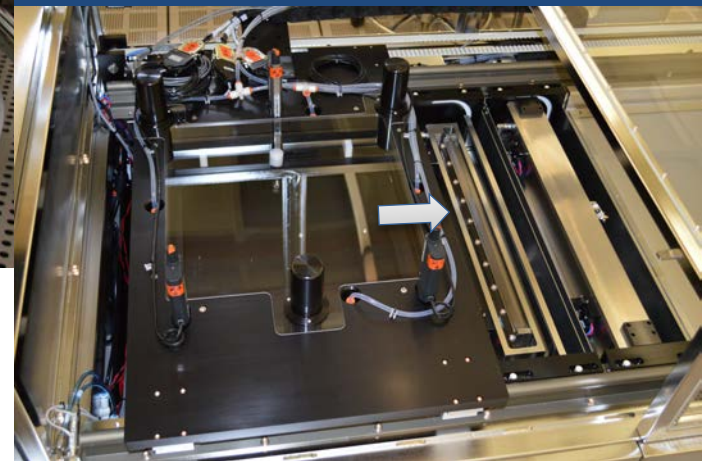
Dip Coating



Spin Coating



Meniscus Coating



Material	Coating Solution	Coating Method
Borosilicate glass	Sol D in sec-butanol	Meniscus
Fused Silica	Sol A in ethanol	Dip coating (ammonia treated)
KDP KD*P	Sol D in sec-butanol Sol E in decane Sol D in ethanol	Spin Coating

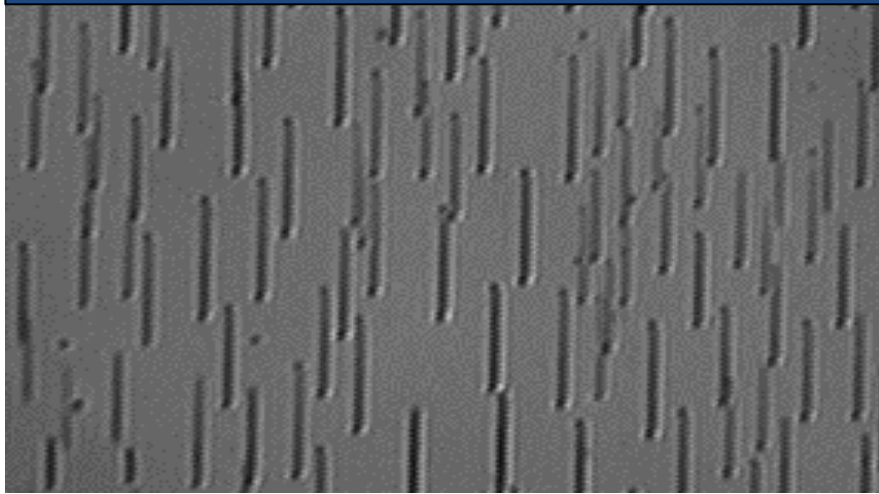
Intermission Story



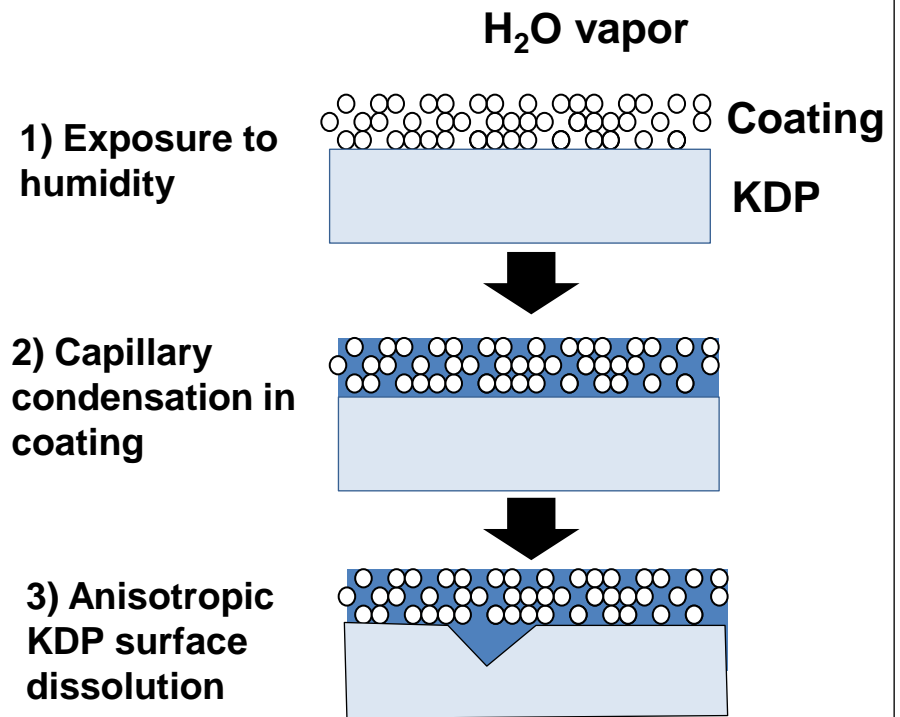
**3+ hr Progress Meetings
+ Cigars**

The silica colloid's hydrophilic nature is detrimental to KDP optics due to etchpit formation

Microscope images of etchpits
KDP surface



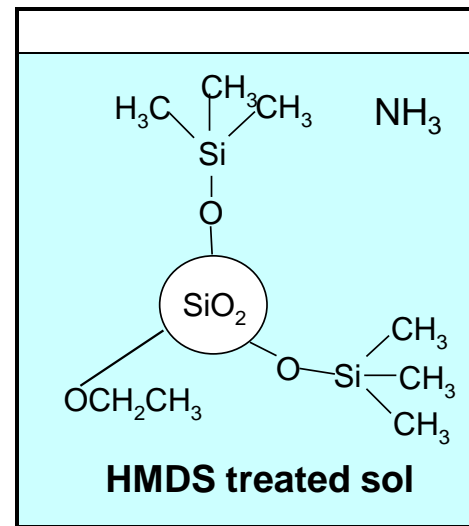
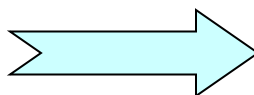
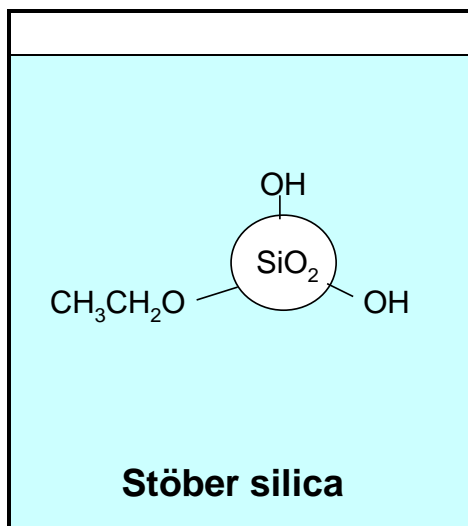
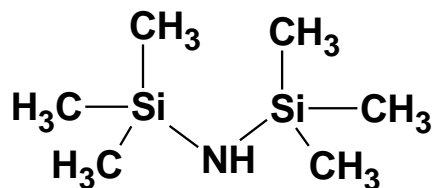
Formation of etchpits on KDP



Hence, we developed a hydrophobic colloidal silica AR coating

Trimethylsilyl (TMS) sols are prepared by adding hexamethyldisilazane (HMDS)

Surface modification is performed in solution, not by vapor treatment

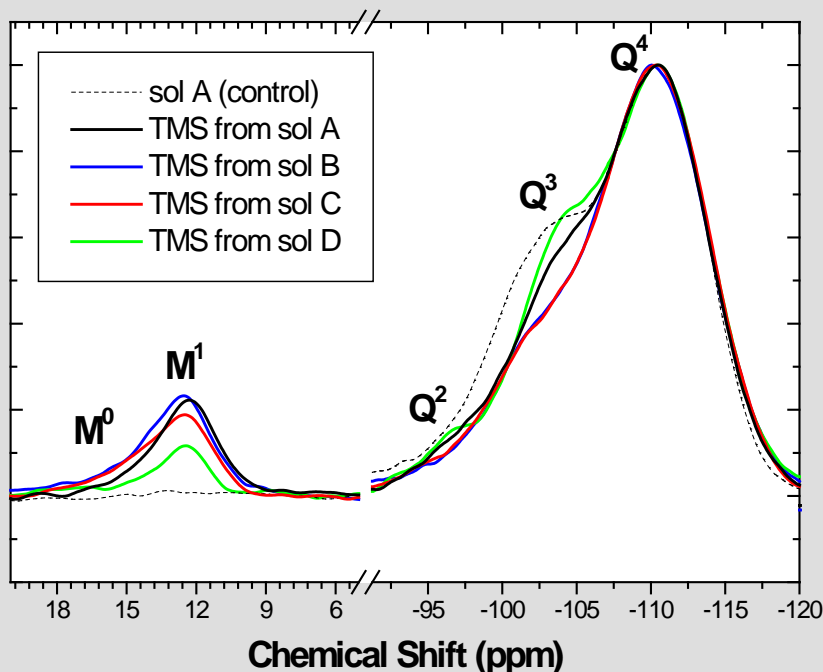


Degree of TMS functionalization, depends on:

- 1) Starting surface chemistry
- 2) Reaction time
- 3) Reactant concentration

Highest TMS coverage occurs using Sol B

TMS Sol: ^{29}Si MAS NMR Spectra



M^1 peak is due to TMS species

- M^1 species replace Q^2 and Q^3 species which are surface silanol species

- Can quantify TMS coverage (C) as:

$$C = \frac{A_{M^1} \cdot 100\%}{A_{M^1} + A_{Q^2} + A_{Q^3}}$$

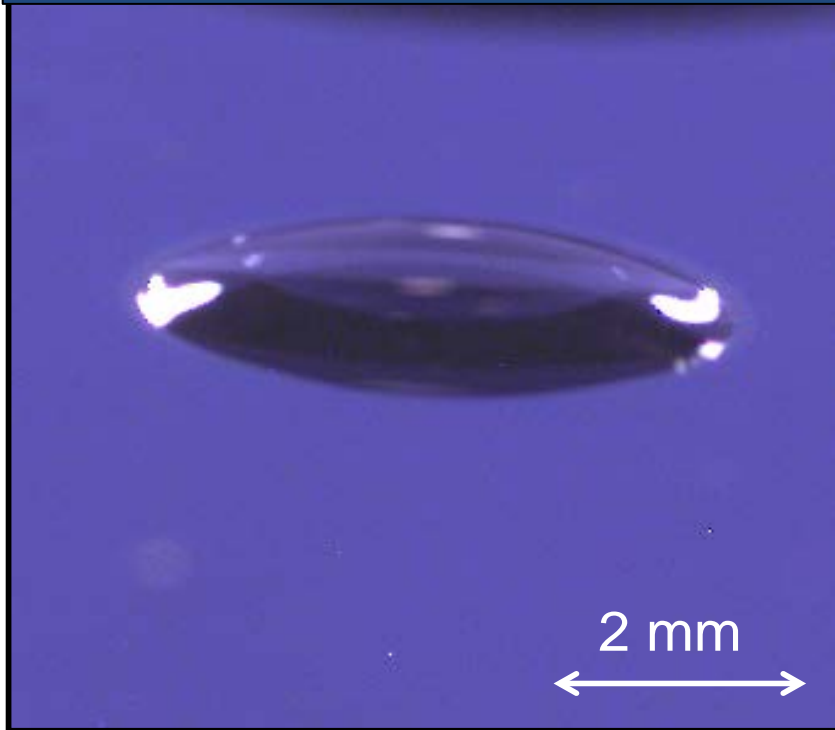
A = peak area

	C
Sol A	14.7%
Sol B	22.7%
Sol C	14.6%
Sol D	5.4%

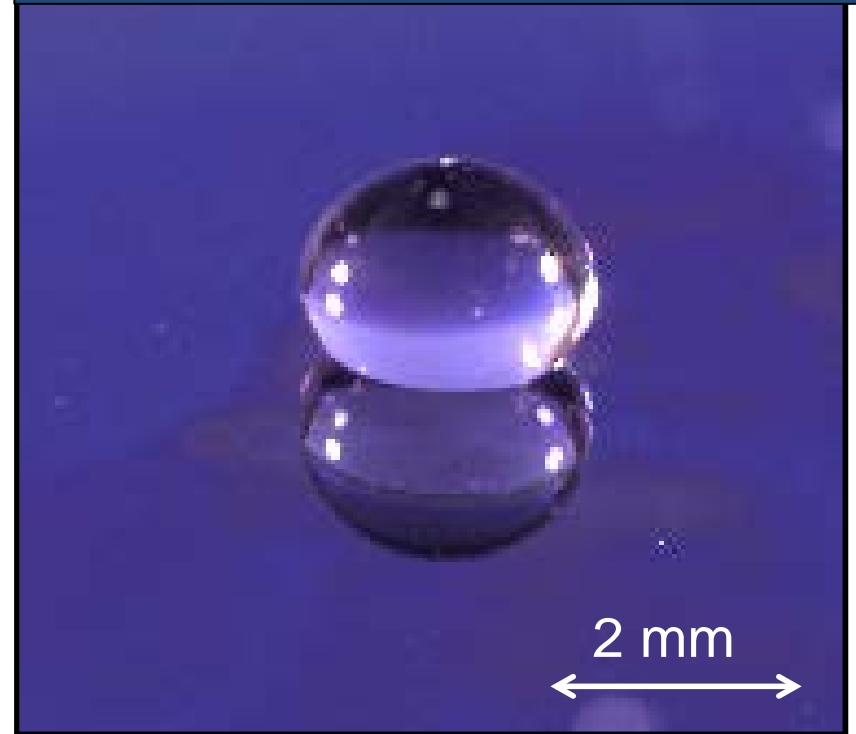
Sol with lowest ethoxy surface provide greatest TMS coverage

The hydrophobic nature of the HMDS sol can be easily observed using the water droplet test

H_2O drop on
standard coating



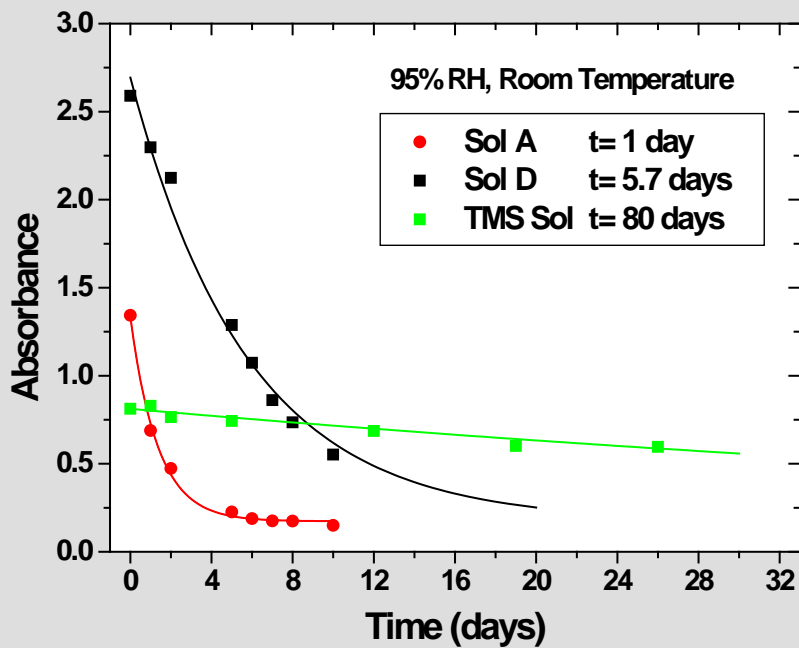
H_2O drop on
HMDS coating



Suratwala et. al. *J. Non-Cryst. Solids* 316 (2003) 349

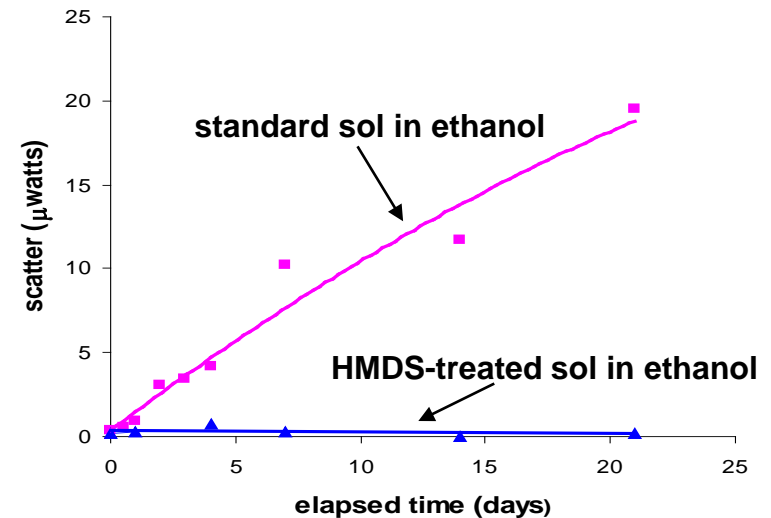
The TMS sol show greater chemical stability and also prevent etchpits on KDP surfaces

Ethoxy IR absorbance (2975 cm^{-1})

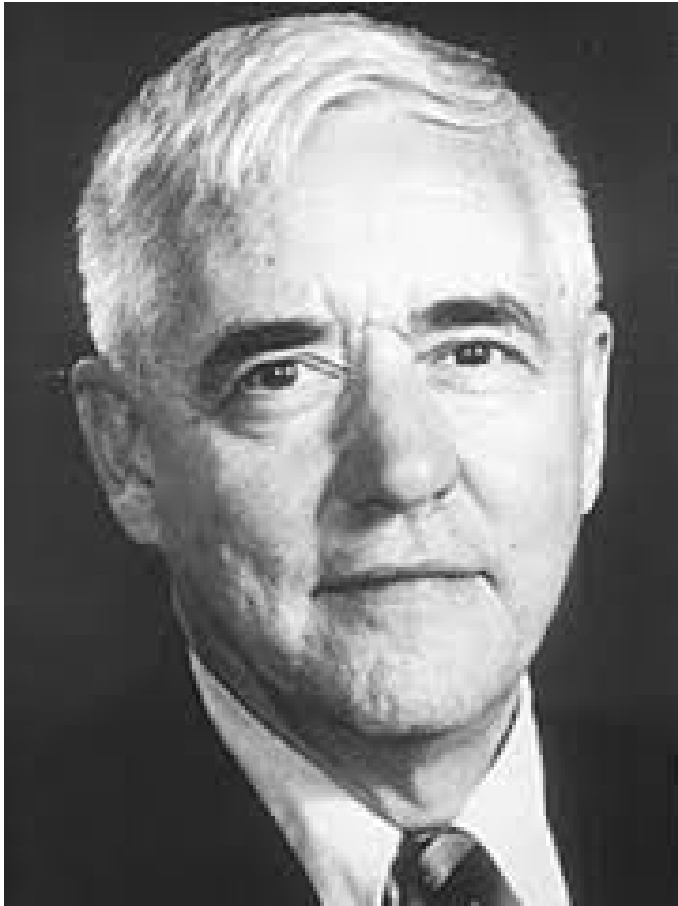


**Ethoxy hydrolysis is slowest
in TMS sols**

Optical scatter vs time



Intermission Story



Dinner at Uhlmann's house with Eugene

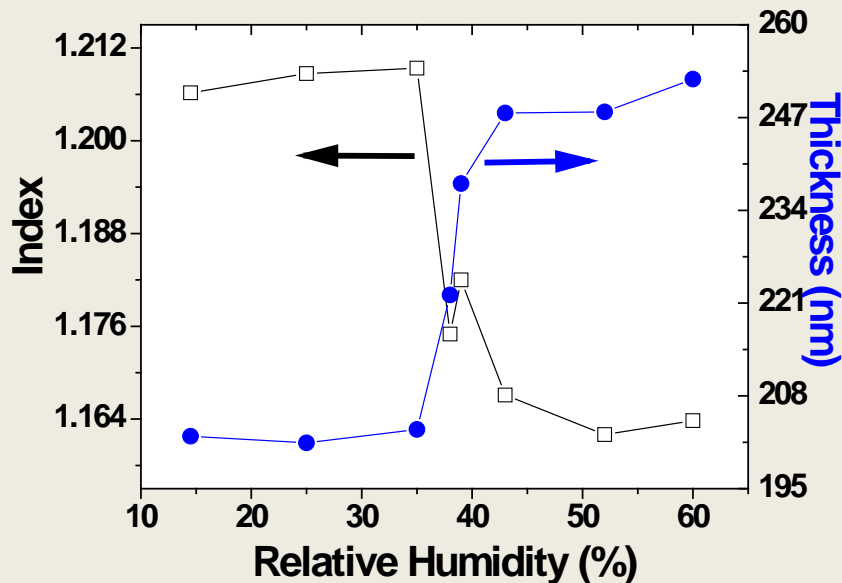
Outline

Surface Chemistry & HMDS Hydrophobic Coating

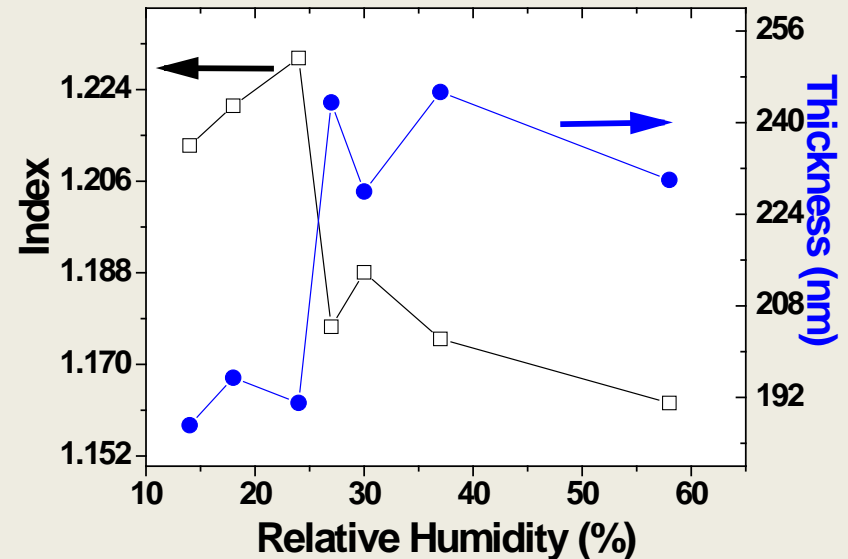
Coating Microstructure (effect of Humidity)

Change in humidity during coating process causes an abrupt change in index and thickness

Sol A : Spin Coating

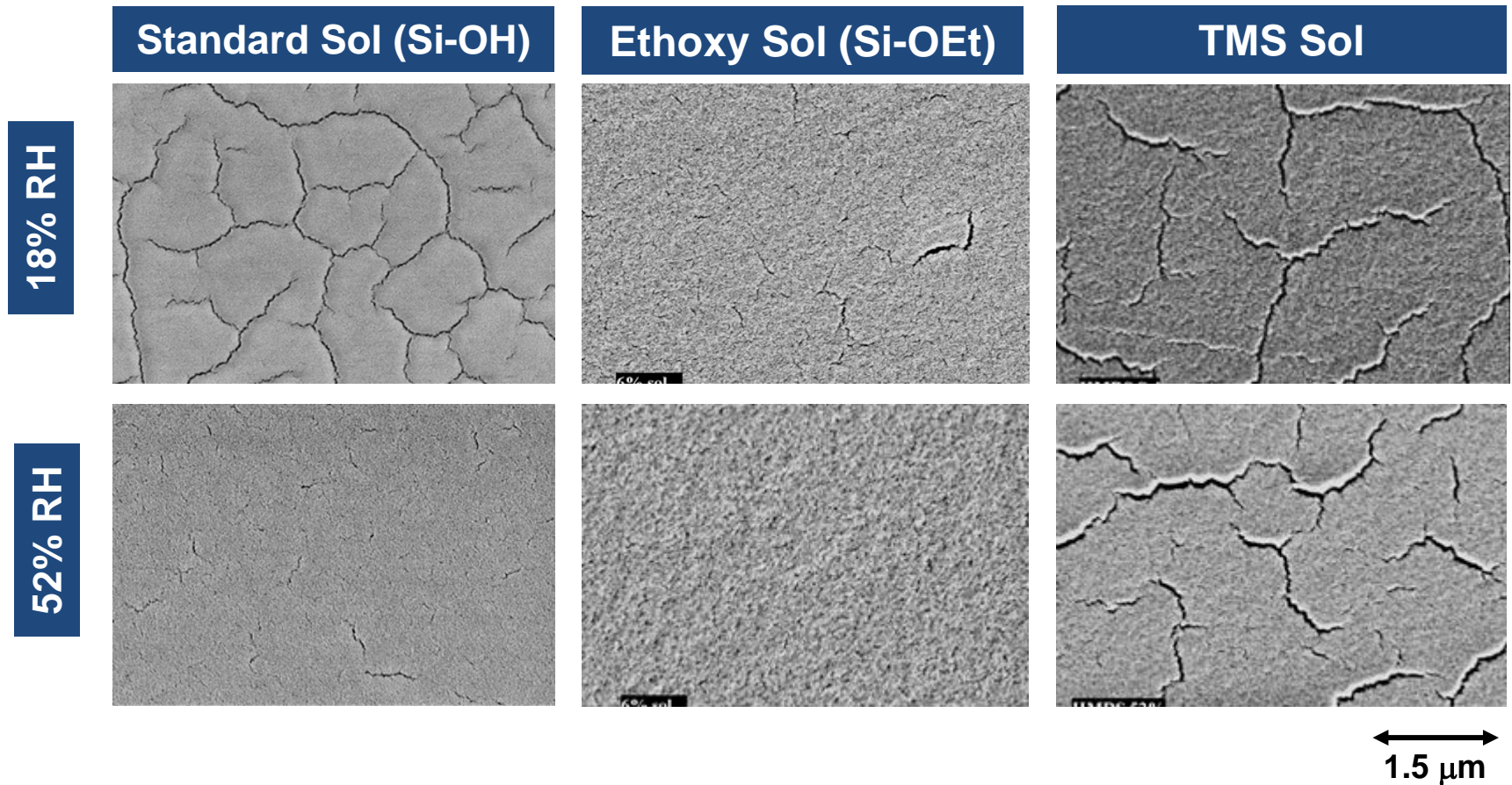


Sol B : Spin Coating



T. Suratwala et. al. *J. Non-Crystal. Solids* 349 (2004) 368

Si-OH sol coating formation is affected strongly by humidity, but TMS sol is not



Shrinkage occurs after the stagnation point because coating mass is constant

Optical Path Length

$$OPL = n_f t_f$$

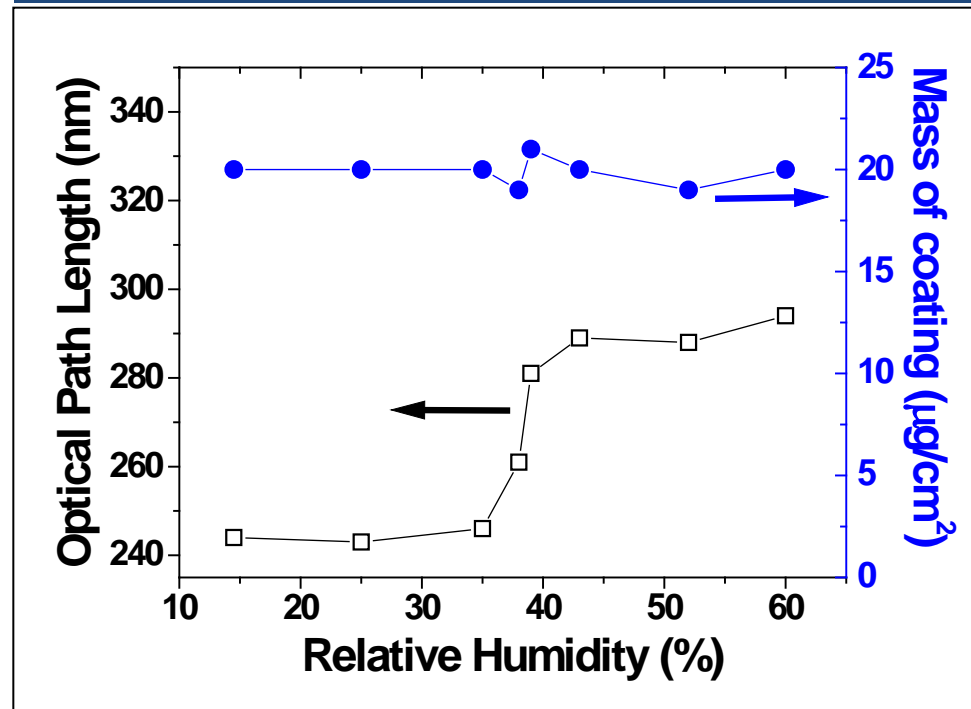
Areal Mass of coating

$$m_f = t_f f_{SiO_2} \rho_{SiO_2}$$

Linear Composite Model

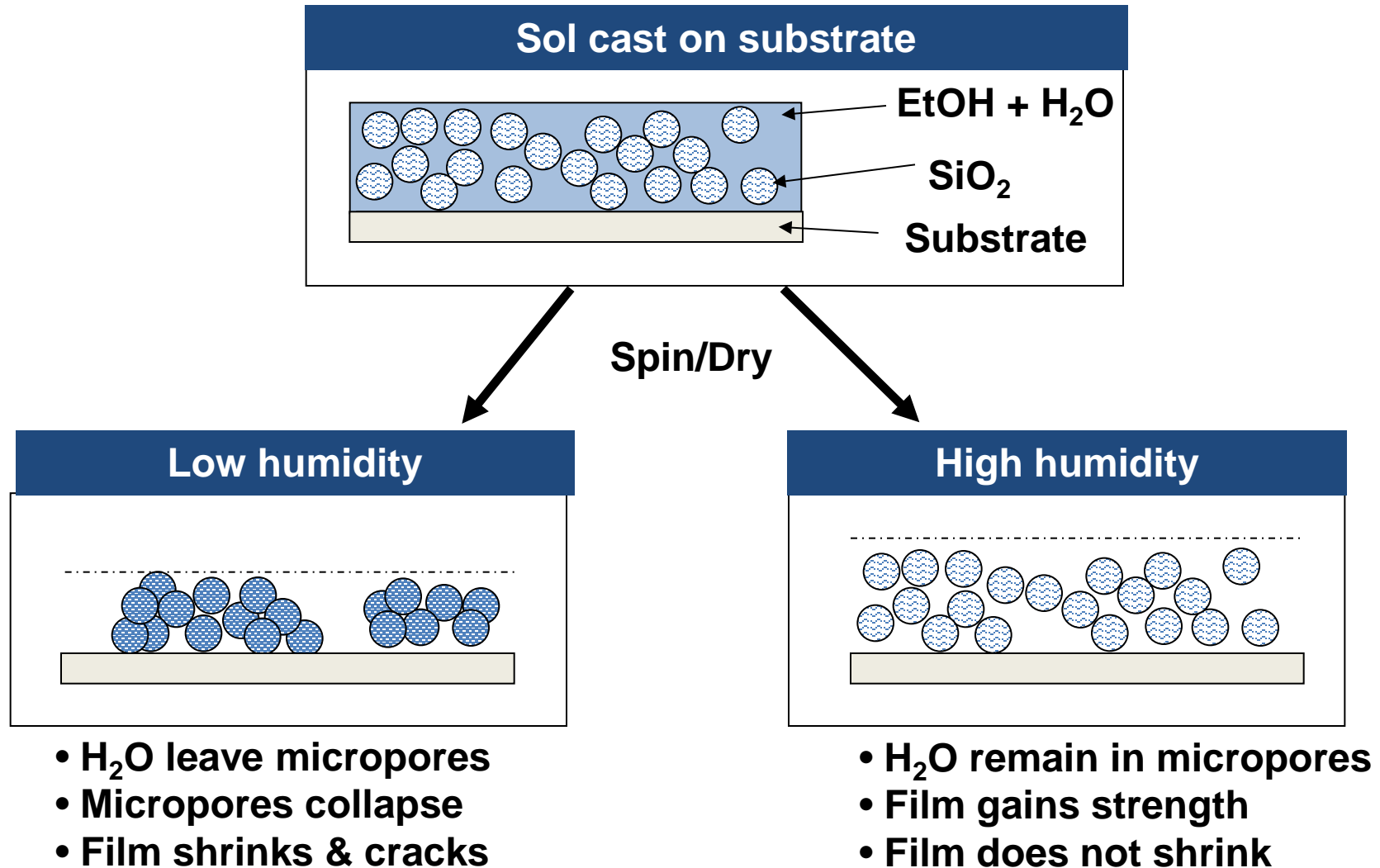
$$n_f = n_{SiO_2} f_{SiO_2} + n_{air} (1 - f_{SiO_2})$$

OPL & Coating mass vs RH

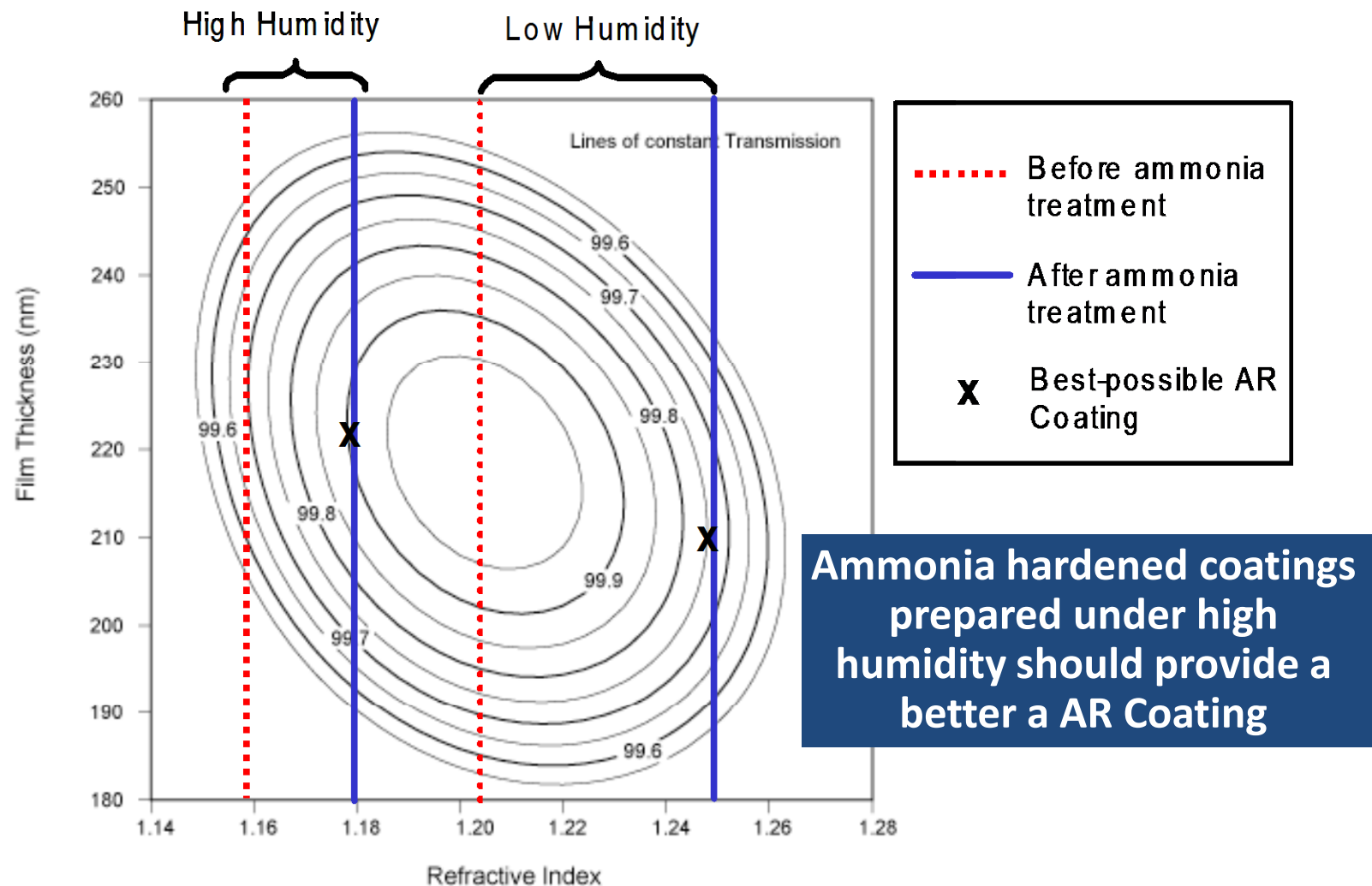


Optical path changes → humidity will affect AR properties
Mass of coating constant → shrinkage due to change in particle packing

Film shrinkage is governed by balance between pore shrinkage stress (capillary pressure) & silica strength (condensation amount)



The effect of humidity is accounted for in order to make optimized AR coating



Acknowledgements

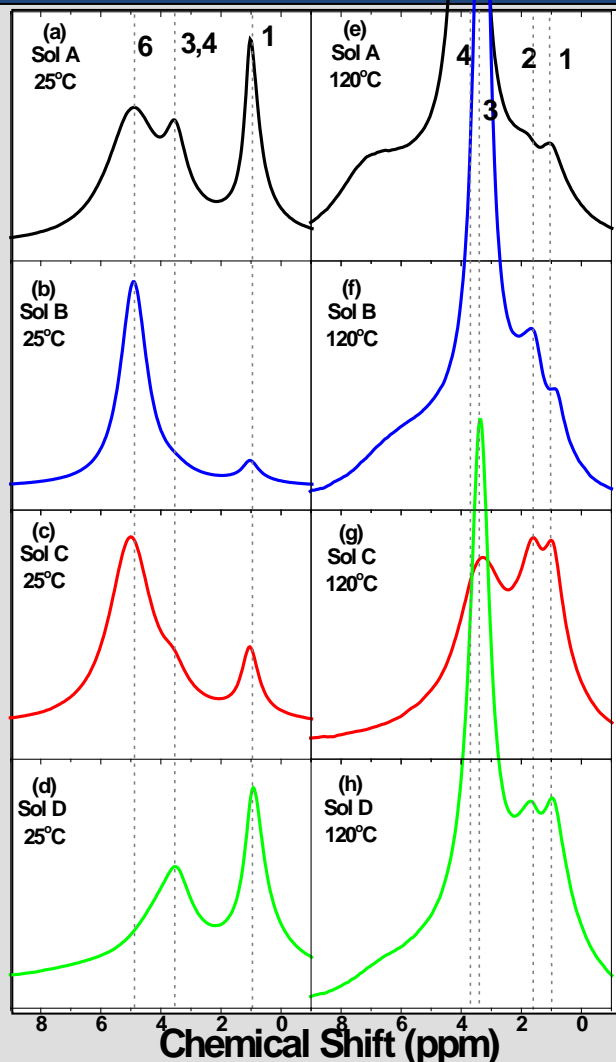
**I. M. Thomas
M. L. Hanna
E. L. Miller
P. K. Whitman
P. R. Ehrmann
R. S. Maxwell
A. K. Burnham
J. Fair
J. Hughes
M. Monticelli
C. Thorsness
D. VanBlarcom
P. Miller**





^1H MAS NMR is used to quantify surface chemistry of four silica sols

^1H NMR Spectra



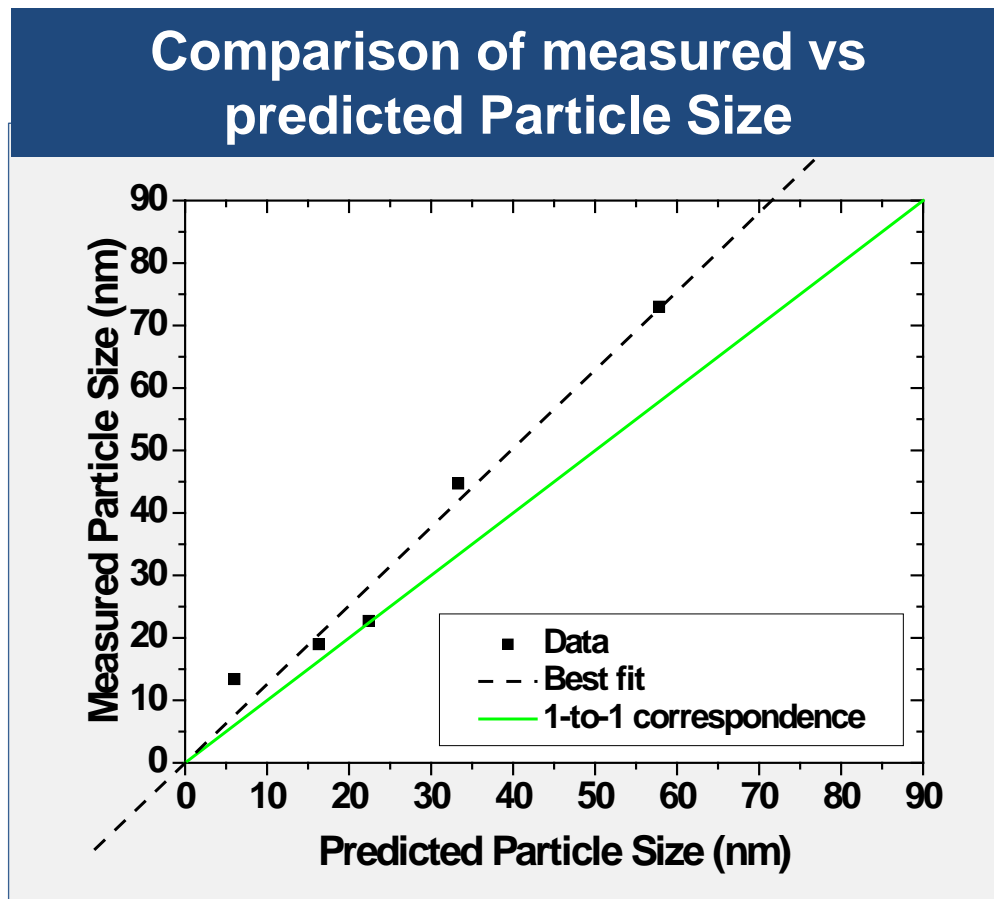
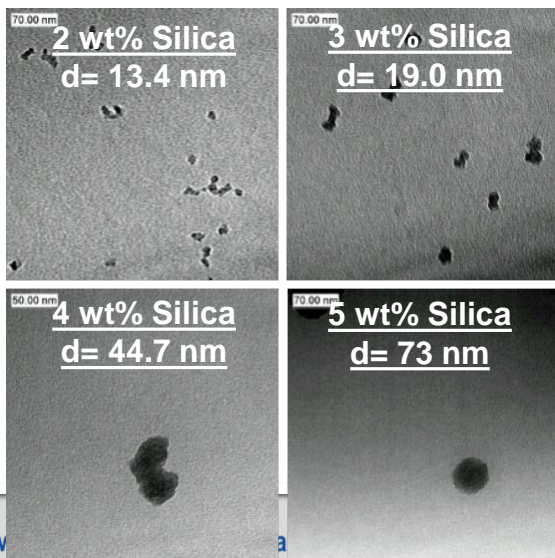
Peak Number	Chemical Shift (ppm)	Chemical species
1	1.0	OCH_2CH_3
2	1.7	Si-OH (isolated)
3	3.5	H_2O (physically absorbed)
4	3.7	OCH_2CH_3
5	1-8 (broad)	Si-OH (hydrogen bonded)
6	4.9	H_2O (Liquid like)

	%OEt	%SiOH (isolated)	%SiOH (Hydrogen bonded)
Sol A	8	17	75
Sol B	2	43	55
Sol C	21	75	4
Sol D	16	43	41

Silica sols can be made to have different ethoxy, isolated silanol, and hydrogen bonded silanols concentrations

There are many factors that effect final particle size of colloids grown by Stober process

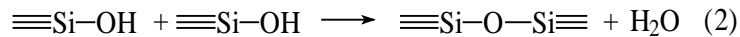
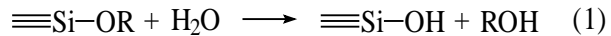
Parameter	Effect on Particle Size
[TEOS]	↓
[NH ₃]	↑
[H ₂ O]	↑
Solvent MW	↑
Temperature	↓



Model by Bogush et. al. Journal of Colloid and Interface Science, 142 (1), (1991)

There are three basic reactions that occur during sol gel processing with various silicate species that can form

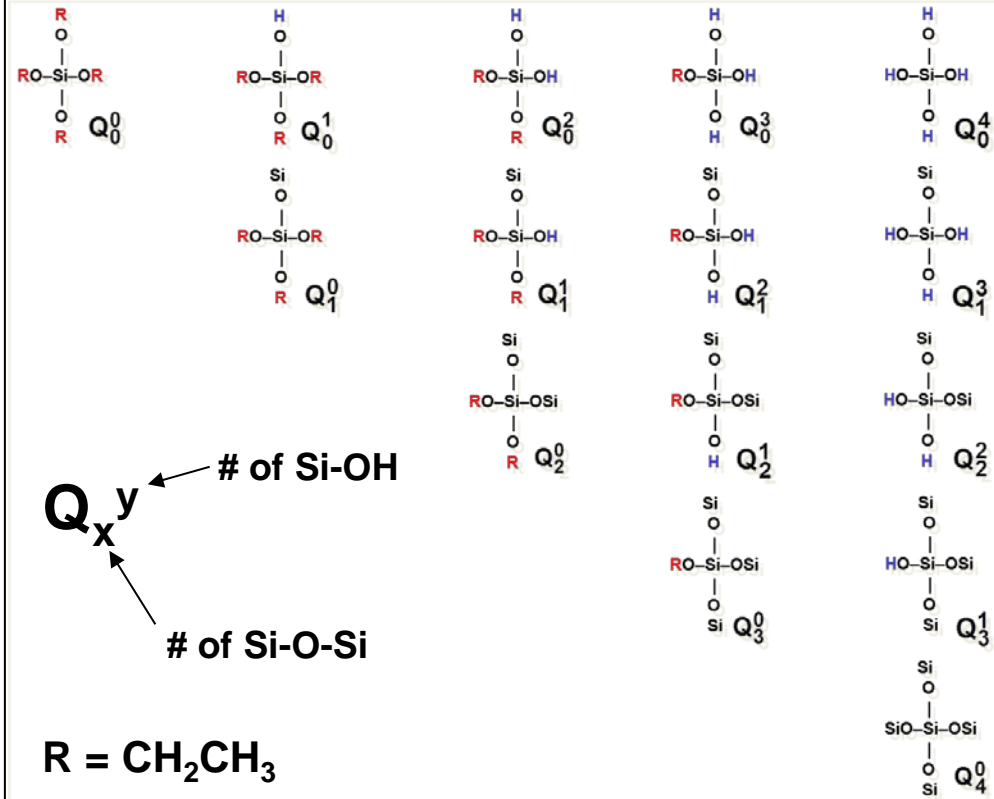
Hydrolysis & Condensation



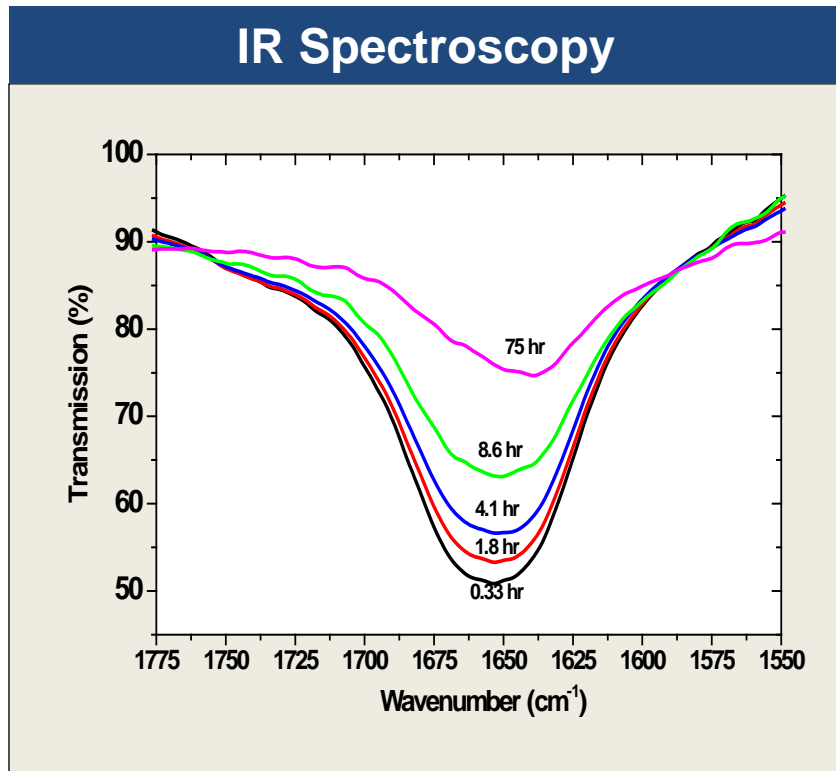
Overall Reaction



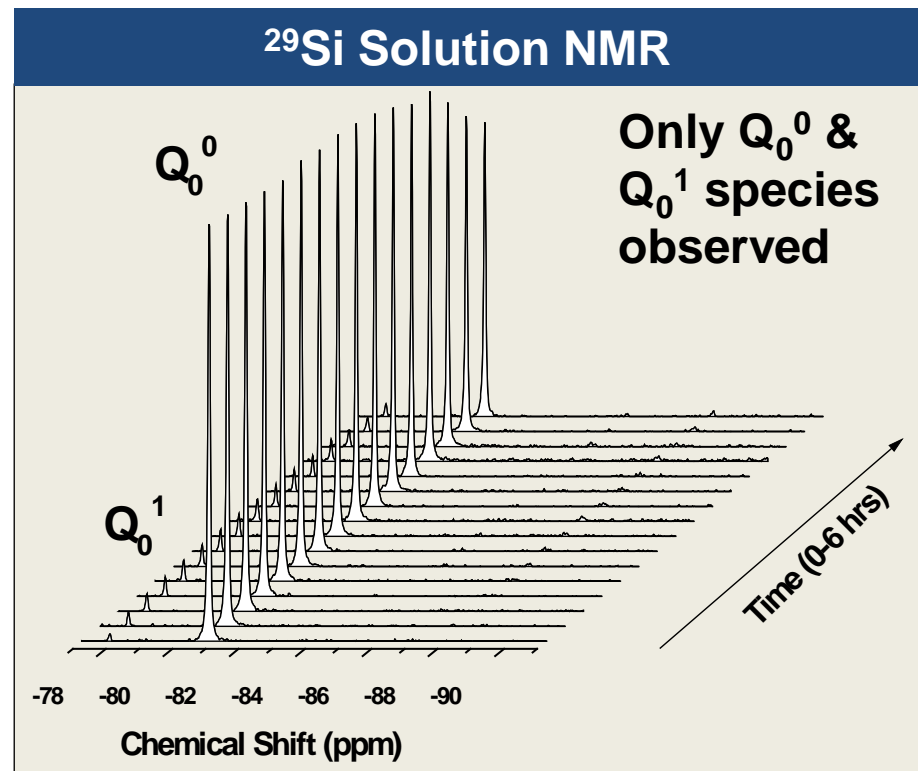
Various silicate species



The reaction kinetics were determined by monitoring the H₂O concentration (IR spectroscopy) and selected Q species (solution Si NMR) vs time



- [H₂O] monitoring the H-O-H bending vibration at 1650 cm⁻¹



- Q species that become part of the colloid are not detected
- Q₀⁰ hydrolysis is rate limiting

Simple kinetic model does a good job at predicting the concentration of species & particle size as a function of time

Rate Equations

$$\frac{d[Q_0^0]}{dt} = -k_1 [Q_0^0][H_2O]$$

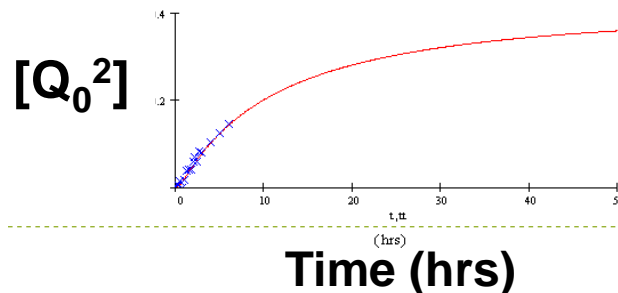
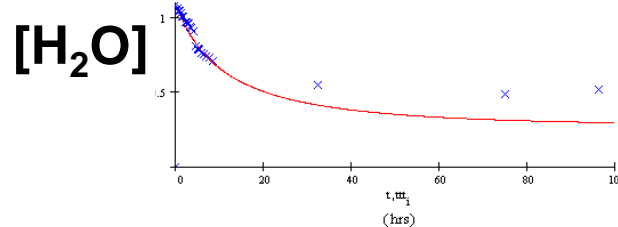
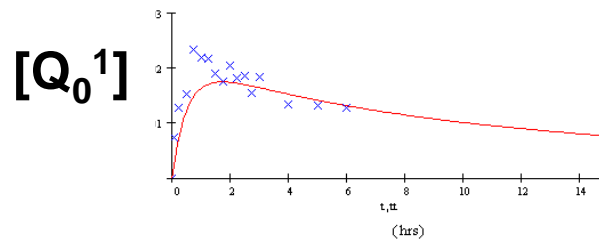
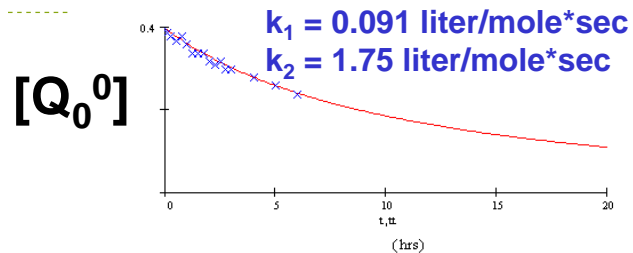
$$\frac{d[Q_0^1]}{dt} = k_1 [Q_0^0][H_2O] - k_2 [Q_0^1][H_2O]$$

$$\frac{d[H_2O]}{dt} = -k_1 [Q_0^0][H_2O] - k_2 [Q_0^1][H_2O]$$

$$\frac{d[Q_0^2]}{dt} = k_2 [Q_0^1][H_2O]$$

- The rate of $Q_0^1 \rightarrow Q_1^0$ is small
- Q_0^2 is simply a transient species that quickly condenses to form the colloid

Model Results



PS prediction

$$d = \left(\frac{6 [Q_0^2] \text{ MW}_{\text{SiO}_2}}{\pi n \rho} \right)^{1/3}$$

